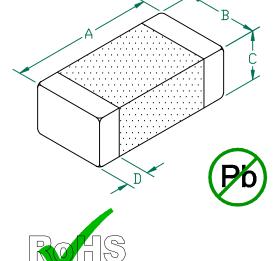
### PHYSICAL DIMENSIONS:

## HF1206J150R-10

## UNCONTROLLED DOCUMENT



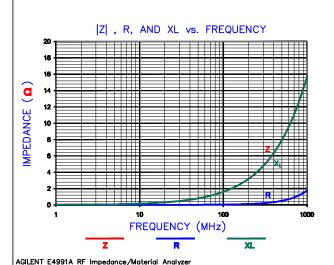
Compliant

ELECTRICAL CHARACTERISTICS:			
Z @ 1GHz ( <b>Ω</b> )		DCR ( $\Omega$ )	Rated Current
Nominal	15		
Minimum	11		
Maximum	19	0.06	1000 mA

NOTES: UNLESS OTHERWISE SPECIFIED

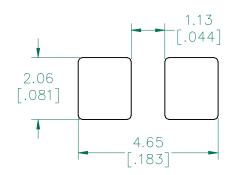
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. TERMINATION FINISH IS 100% TIN.

# Z vs. FREQUENCY IMPEDANCE UNDER DC BIAS 18 16 14 12 220 19 10 500ma 1000ma 100 FREQUENCY (MHz)



HP 16092A Test Fixture. TEST REF. 3124

## LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [0.030] to this dimension)

## RECOMMENDED SOLDERING CONDITIONS REFLOW SOLDERING PRE-HEATING SOLDERING NATURAL COOLING 130 [266] 100 SECONDS 5 - 10 SECONDS

